# 2-1761609-6 ACTIVE

#### **AMP-LATCH**

TE Internal #: 2-1761609-6

Wire-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Right Angle,

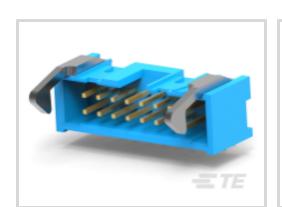
Through Hole - Solder, 2 Row, Plug, Low Profile, Ribbon Cable

Connectors

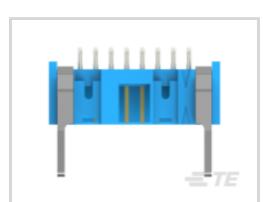
View on TE.com >

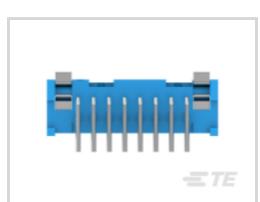


Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors











Connector System: Wire-to-Board

Number of Positions: 16

Centerline (Pitch): 2.54 mm [ .1 in ]

PCB Mount Retention: Without

PCB Mount Orientation: Right Angle

### **Features**

### **Product Type Features**

Connector System	Wire-to-Board
Connector & Housing Type	Plug
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly
Ribbon Cable Connector Header Type	Pin Header
Configuration Features	
Number of Positions	16
PCB Mount Orientation	Right Angle

### **Housing Features**

Number of Rows

Centerline (Pitch)	2.54 mm[.1 in]
Mating Entry Location	Тор
Housing Material	PBT

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### Mechanical Attachment



PCB Mount Retention	Without
Mating Alignment Type	Center
Mating Retention	With
Mating Retention Type	Ejection Latch
Connector Mounting Type	Board Mount
Panel Mount Feature	Without
Mating Alignment	With
PCB Mount Alignment	Without

#### **Termination Features**

Termination Method to PCB	Through Hole - Solder
Termination Post & Tail Diameter	.64 mm[.025 in]
Termination Post & Tail Length	2.6 mm[.102 in]

### **Dimensions**

Row-to-Row Spacing	2.54 mm[.1 in]
Shrouded End Dimension	3.76 mm[.148 in]
Connector Height	9.19 mm[.36 in]
Connector Length	27.94 mm[1.1 in]

### **Body Features**

Connector Profile	Low
Primary Product Color	Blue

### **Contact Features**

Contact Current Rating (Max)	1 A
Contact Underplating Material	Nickel
Mating Pin Diameter	.64 mm[.025 in]
Contact Mating Area Plating Material Thickness	.762 μm[30 μin]
Contact Shape & Form	Square
PCB Contact Termination Area Plating Material Thickness	2.54 μm[100 μin]
PCB Contact Termination Area Plating Material Thickness  Contact Mating Area Plating Material	2.54 µm[100 µin] Gold Flash
Contact Mating Area Plating Material	Gold Flash

### Operation/Application



Circuit Application	Signal
Usage Conditions	
Operating Temperature Range	-65 – 105 °C[-85 – 221 °F]
Housing Temperature Rating	High
Other	
EU RoHS Compliance	Compliant
EU ELV Compliance	Compliant
Electrical Characteristics	
Operating Voltage	250 VAC
Insulation Resistance	5000 ΜΩ
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	19
Packaging Method	Tube

### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous

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materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

### Compatible Parts















## Customers Also Bought

















### **Documents**

Product Drawings
IDC LOW PRO HDR 16P RA SHT LAT

Wire-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Right Angle, Through Hole - Solder, 2 Row, Plug, Low Profile, Ribbon Cable Connectors



### English

**CAD Files** 

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_2-1761609-6\_C.2d\_dxf.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2-1761609-6\_C.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_2-1761609-6\_C.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

### **Product Specifications**

**Product Specification** 

English

### **Agency Approvals**

**UL Report** 

English